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68. (Amended) A chip package comprising:  
packaging material having a first side and a second side,  
a lead extending from the first side of the packaging material, and  
a first clip portion extending from the second side of the packaging  
material.

69. (Amended) The chip package of claim 68, the packaging material  
having a third side, and further comprising a second clip portion extending from  
the third side of the packaging material.

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80. (Amended) The chip package of claim 79, wherein the metallic  
material comprises beryllium-copper.

Please cancel claim 84

**In the Specification**

Please amend on page 35, the third beginning paragraph, and which extends  
to page 36, that before this subject amendment begins "For another embodiment,  
an edge-mountable chip 2040 may have a C-shaped leads 2042 that wrap around a  
cylinder 2080 extending along the ..." to read as follows:

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--For another embodiment, an edge-mountable chip 2040 may have  
a C-shaped leads 2042 that wrap around a cylinder 2080 extending  
along the bottom of chip 2040 from left to right as illustrated in  
Figure 22. Leads 2042 extend into a pocket or indentation formed  
by an extended portion 2041 of chip 2040. The pocket formed by